

**INDUSTRIAL TECHNOLOGY DEVELOPMENT INSTITUTE
SUPPLEMENTAL ANNUAL PROCUREMENT PLAN FOR YR 2018
Infrastructure Project**

Code (PAP)	Procurement Program/Project	PMO/ End-User	Mode of Procurement	Schedule for Each Procurement Activity				Source of Funds	Estimated Budget (PhP)			Remarks (brief description of Program/Project)
				Ads/Post of IB/REI	Sub/Open of Bids	Notice of Award	Contract Signing		Total	MOOE	CO	
1)	Repair of PTD Buildings to House the Simulation Packaging Testing Laboratory (SPTL Building 1) and Packaging Pilot Plant (Building 2)	PTD Staff	Public Bidding	October 26, 2018	November 19, 2018	1st wk of December 2018	3rd wk of December	GIA	117,000,000.00		117,000,000.00	Construction Project

Prepared by:



MARIA PRITINA A. GAMBOA
BAC-Secretariat

Recommending Approval:


ENGR. NORBERTO G. AMBAGAN, Ph.D.
BAC-Chairperson, Sub-Committee for Infra

Approved by:


DR. DIANA L. IGNACIO
BAC Chairperson


ANNABELLE V. BRIONES, Ph.D.
OIC-Office of the Director

Charge to:

Item 1) DOST-GIA Project "Upgrading and Enhancing the Capacity of the Packaging Technology Division in Packaging and Research and Innovation"